



US00D471165S

(12) **United States Design Patent** (10) **Patent No.:** **US D471,165 S**  
**Williams et al.** (45) **Date of Patent:** **\*\* \*Mar. 4, 2003**

(54) **SURFACE MOUNT PACKAGE**

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(\* ) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/141,963**

(22) Filed: **May 15, 2001**

(51) **LOC (7) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/182**

(58) **Field of Search** ..... D13/182; D14/114;  
257/621, 666, 669, 672, 673, 674, 676,  
684-690, 692, 696, 710, 711, 730, 731;  
361/718, 742, 760, 774, 820

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(57) **CLAIM**

The ornamental design for a surface mount package, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a surface mount package showing our new design;

FIG. 2 is a top plan view thereof;

FIG. 3 is a bottom plan view thereof;

FIG. 4 is a front elevational view thereof;

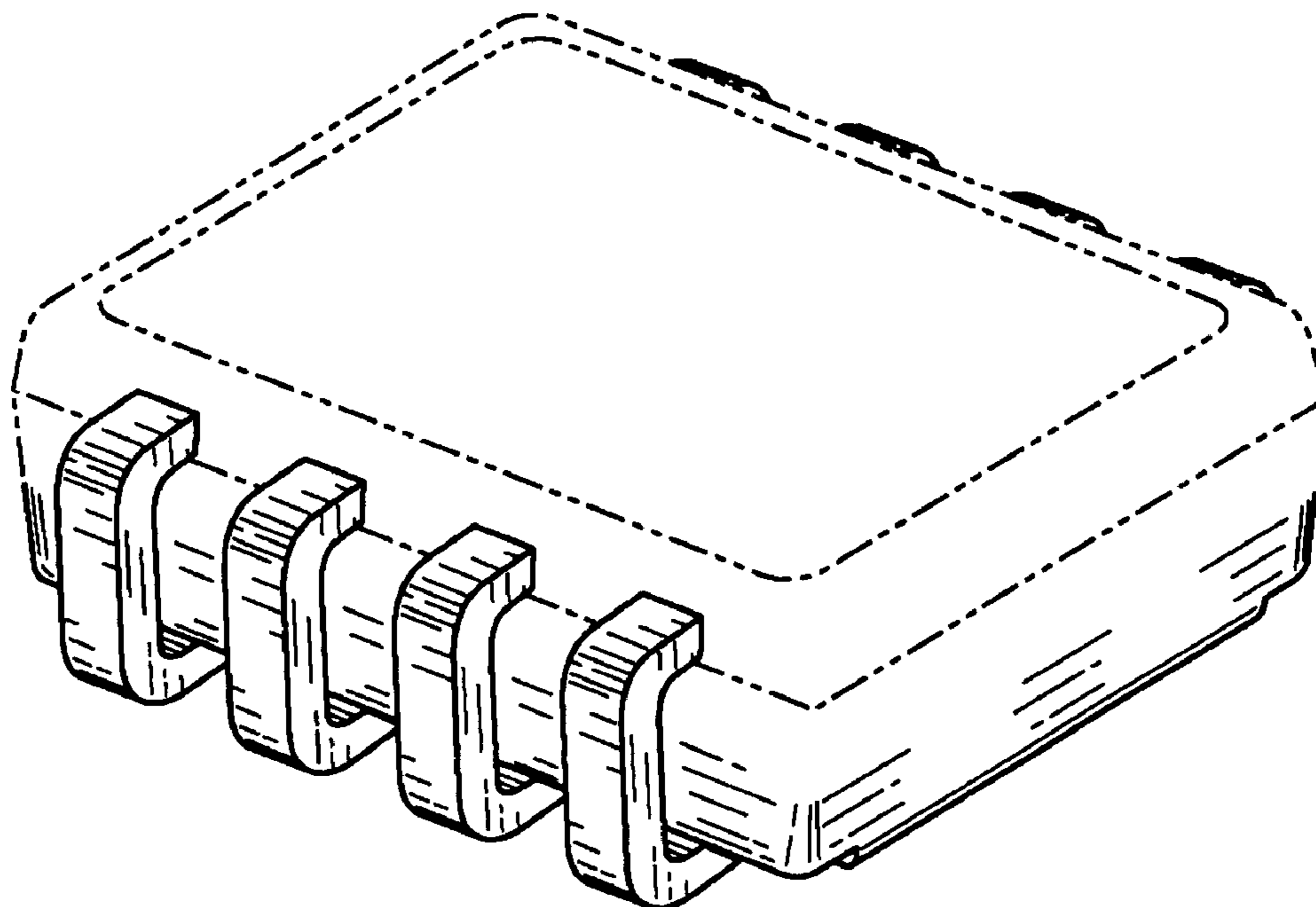
FIG. 5 is a rear elevational view thereof;

FIG. 6 is a left side elevational view thereof; and,

FIG. 7 the right side elevational view thereof.

The broken line showing of the environment is for illustrative purpose only and forms no part of the claimed design.

**1 Claim, 3 Drawing Sheets**



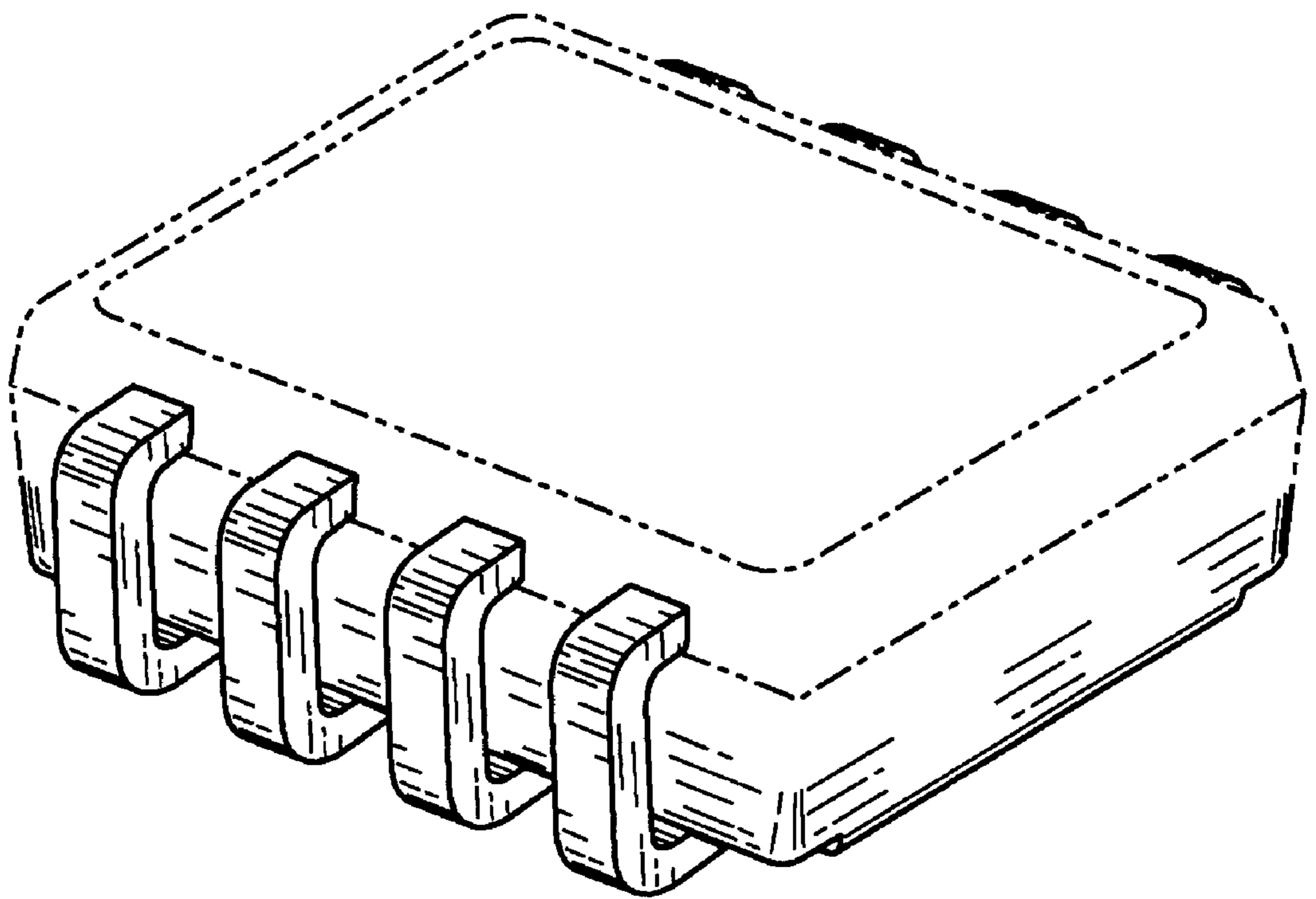


FIG. 1

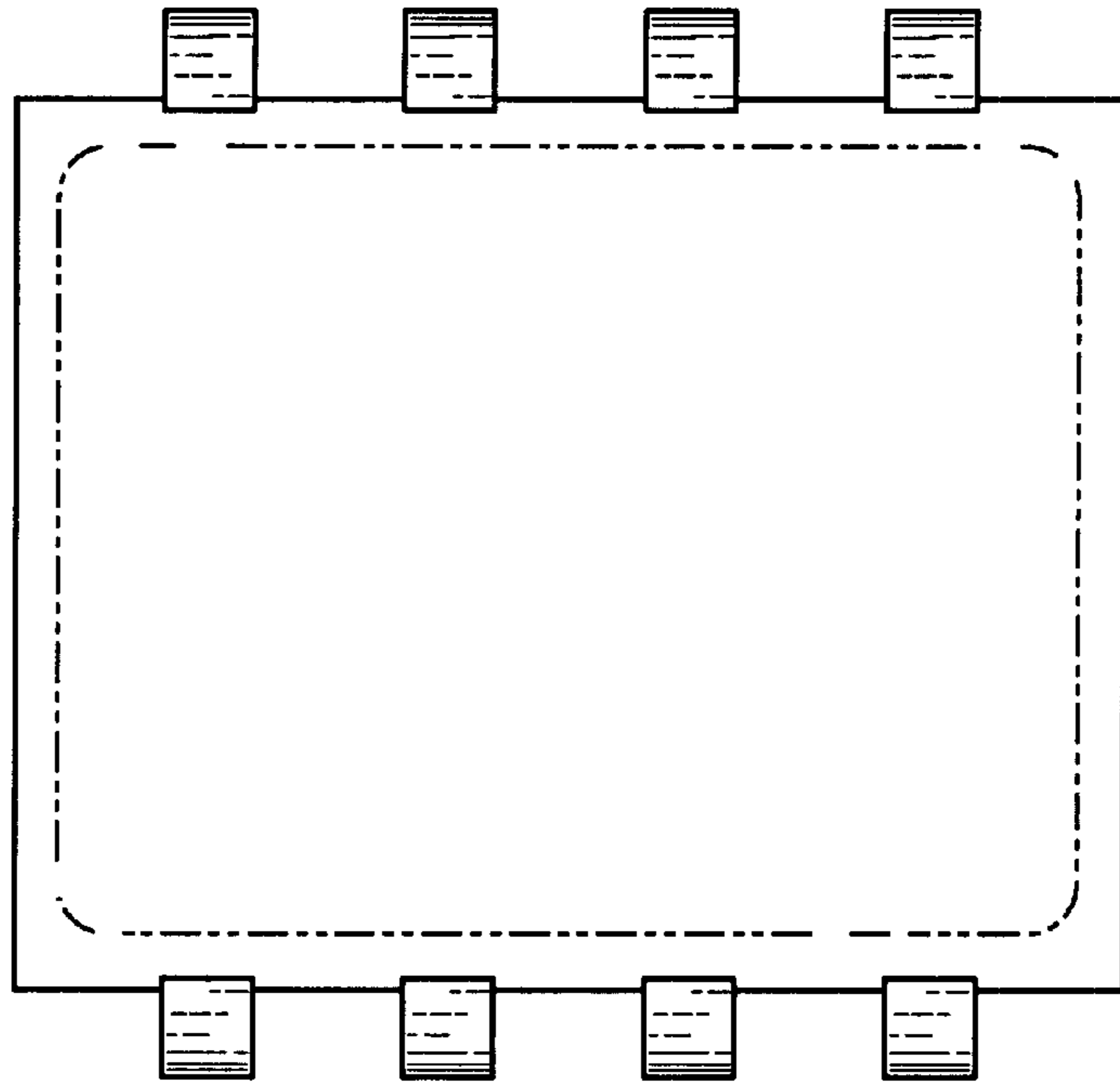


FIG. 2

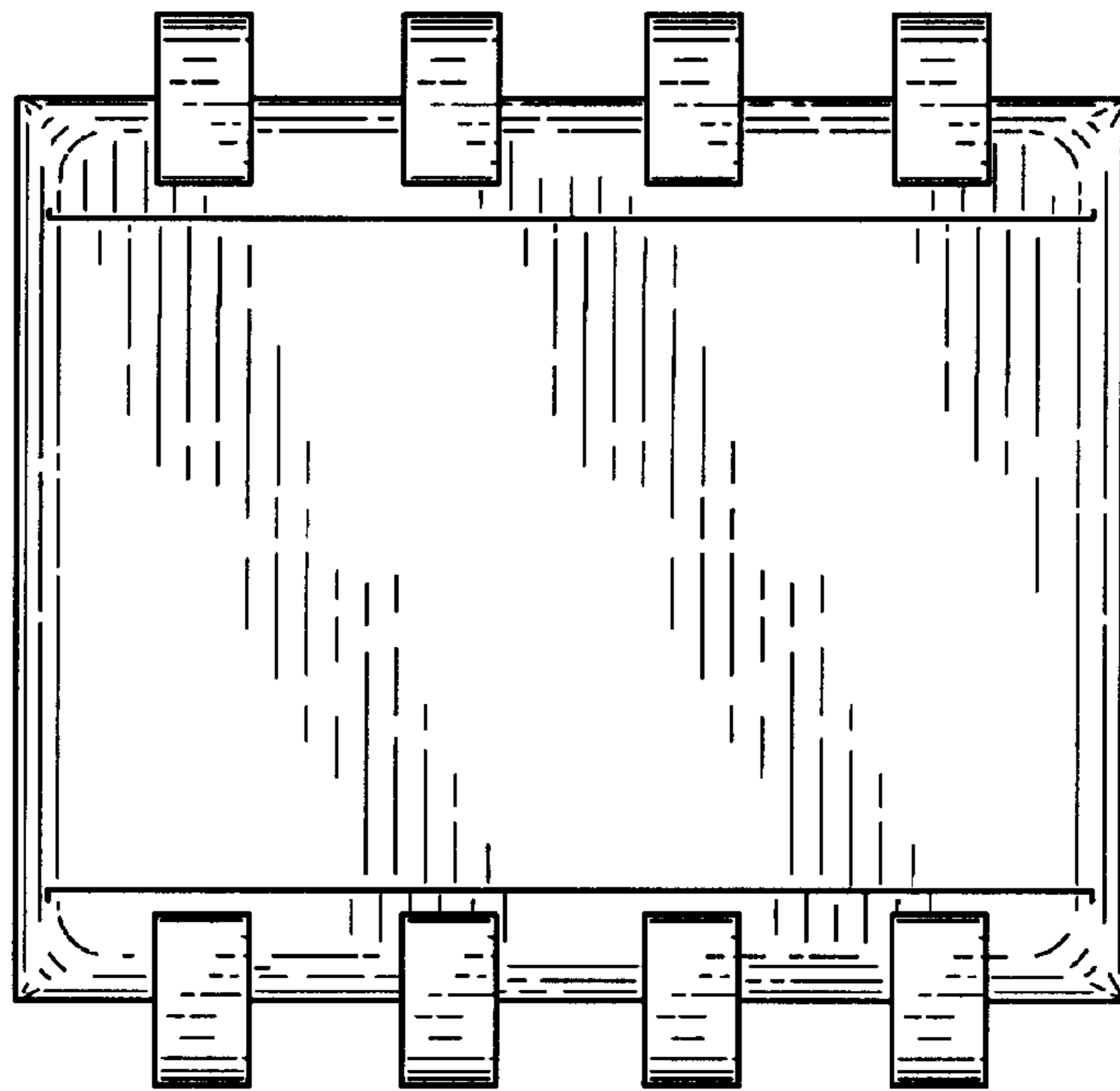


FIG. 3

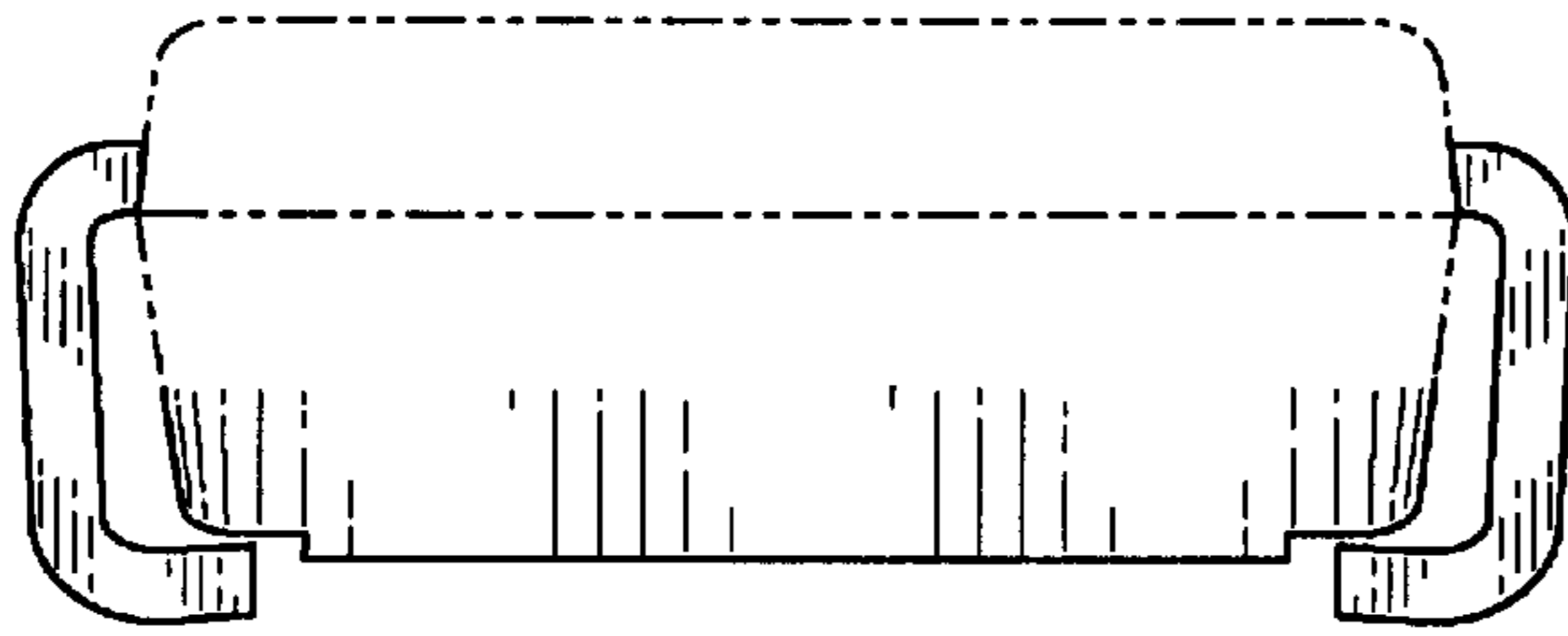


FIG. 4

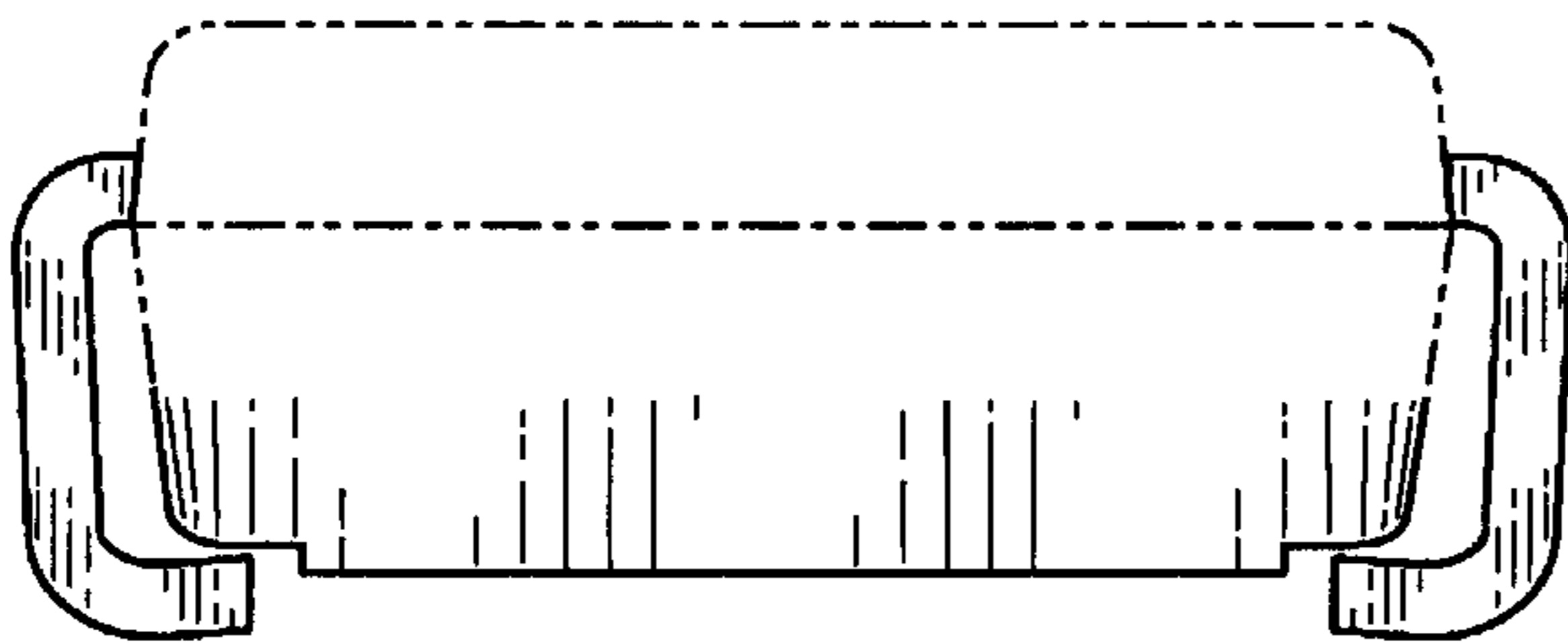


FIG. 5

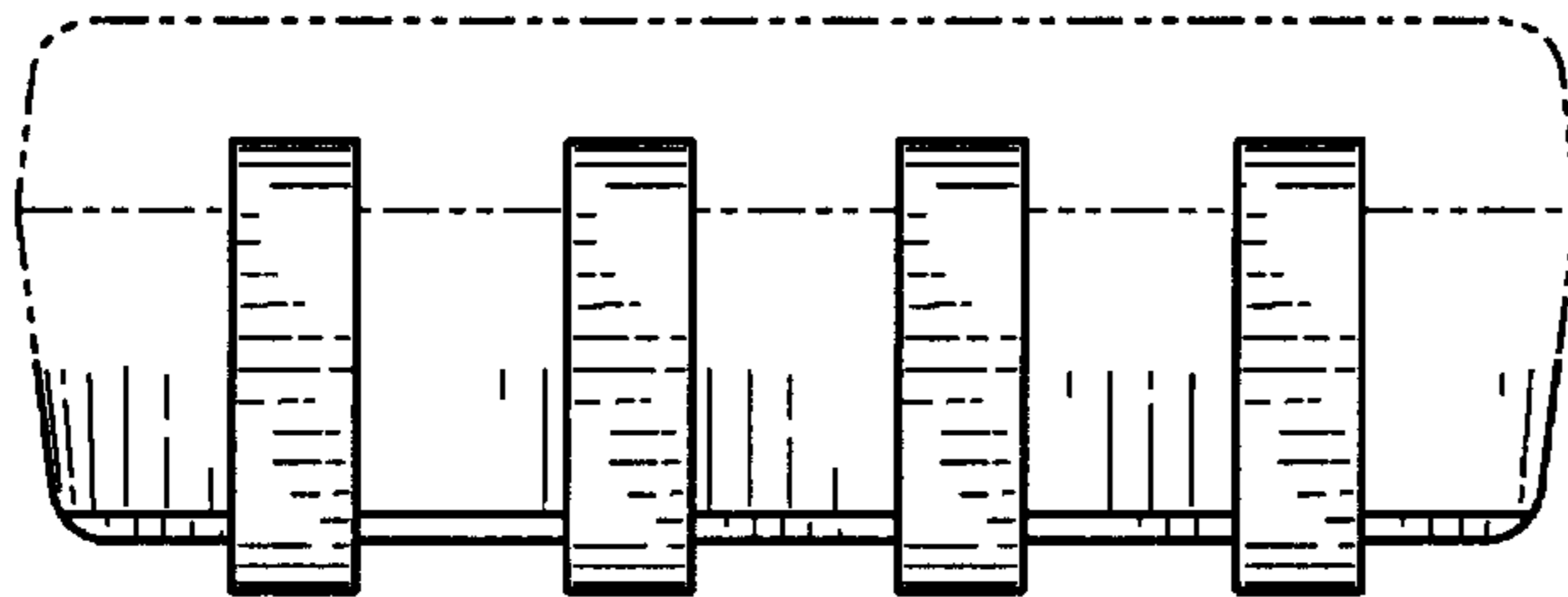


FIG. 6

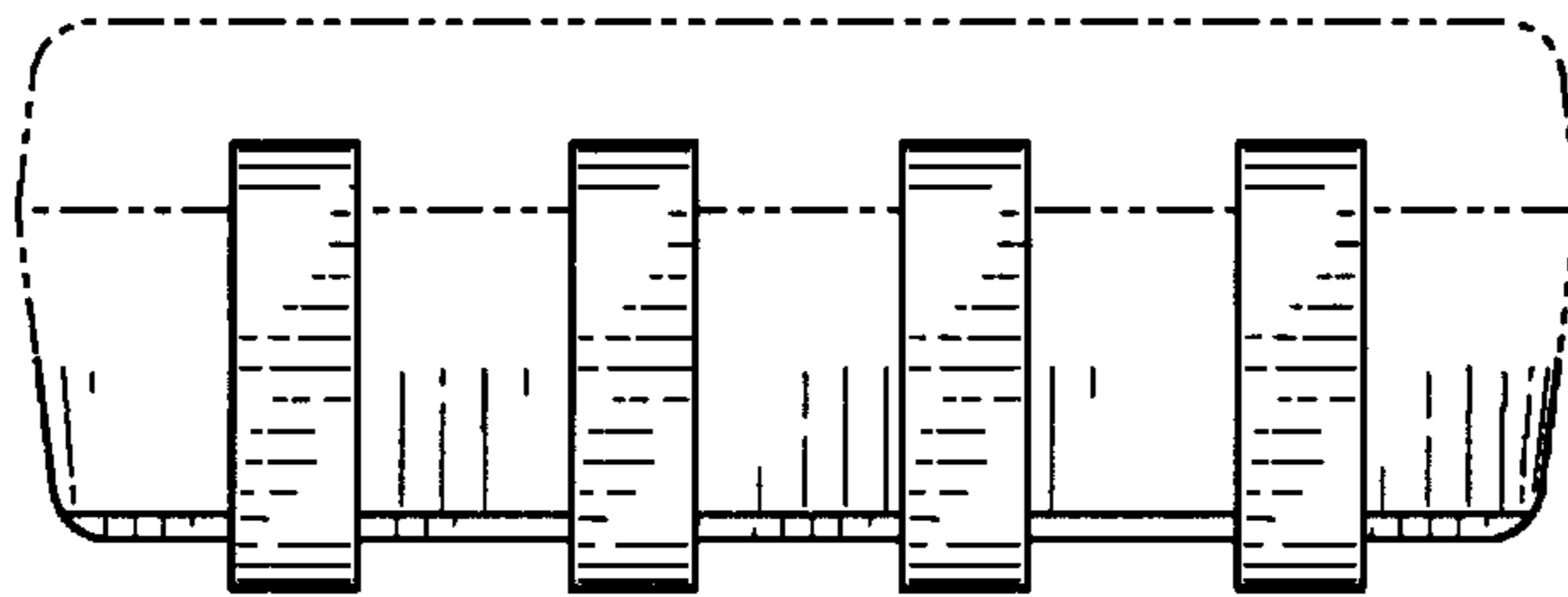


FIG. 7